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FDMC4435BZ-MS

Product specification

Description

The FDMC4435BZ-MS uses advanced trench technology excellent RDS(ON) , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as load switch or in PWM applications .

Features

$V_{DS} = -30V, I_D = -50A$

$R_{DS(ON)} < 25m\Omega @ V_{GS} = -4.5V$

$R_{DS(ON)} < 15m\Omega @ V_{GS} = -10V$

High Power and current handing capability

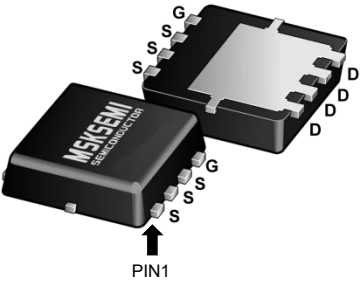
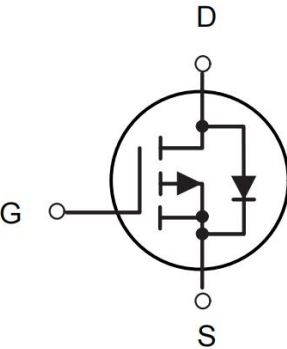

Lead free product is acquired

Surface mount package

Application

- PWM applications
- Load switch
- Power management

Reference News

PACKAGE OUTLINE	P-Channel MOSFET	Marking
 <p>DFN5X6-8L</p>		

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Limit	Unit
VDS	Drain- Source Voltage	-30	V
VGS	Gate- Source Voltage	±20	V
ID	Drain Current-Continuous (Tc=25 °C)	-50	A
	Drain Current-Continuous (Tc= 100 °C)	-24	
IDM	Drain Current-Pulsed (Note 1)	-80	A
Pd	Maximum Power Dissipation (Tc=25 °C)	3	W
	Maximum Power Dissipation (Tc= 100 °C)	1.3	
EAS	Single pulse avalanche energy (Note 5)	231	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C
RθJA	Thermal Resistance, Junction-to-Ambient (Note 2)	41.67	°C/ W

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain- Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250 μA	-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V	-	-	-1	μA
Gate- Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.5	-3	V
Drain- Source On- State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-10A	-	9	15	mΩ
		V _{GS} =-4.5V, I _D =-7A	-	18	25	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-10V, I _D =-10A	-	20	-	S
Input Capacitance	C _{iss}	V _{DS} =-15V, V _{GS} =0V, F=1.0MHz	-	1750	-	PF
Output Capacitance	C _{oss}		-	215	-	PF
Reverse Transfer Capacitance	C _{rss}		-	180	-	PF
Turn-on Delay Time	t _{d(on)}	V _{DD} =-15V, I _D =-10A, V _{GS} =-10V, R _{GEN} =1 Ω	-	9	-	nS
Turn-on Rise Time	t _r		-	8	-	nS
Turn-Off Delay Time	t _{d(off)}		-	28	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Q _g	V _{DS} =-15V, I _D =-10A, V _{GS} =-10V	-	24	-	nC
Gate- Source Charge	Q _{gs}		-	3.5	-	nC
Gate- Drain Charge	Q _{gd}		-	6	-	nC
Diode Forward Current (Note 2)	I _s		-	-	-12	A
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V, I _s =-12A	-	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition: T_J=25°C, V_{DD}=-15V, V_G=10V, L=0.5mH, R_g=25Ω, I_{AS}=-34A

Typical Electrical and Thermal Characteristics

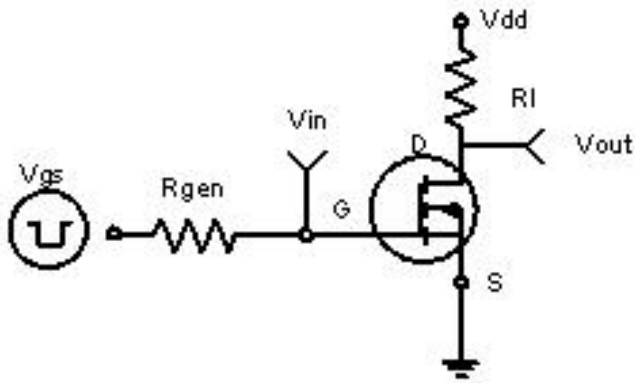


Figure 1: Switching Test Circuit

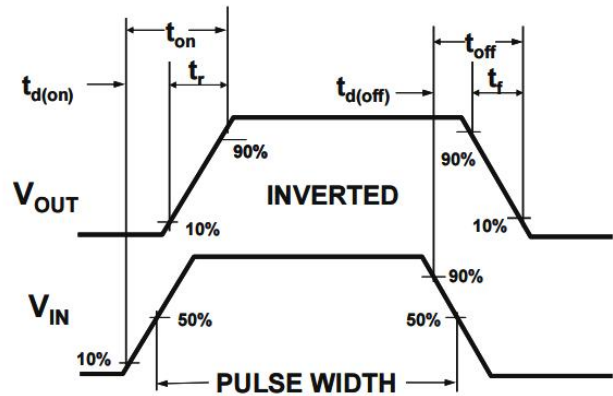


Figure 2: Switching Waveforms

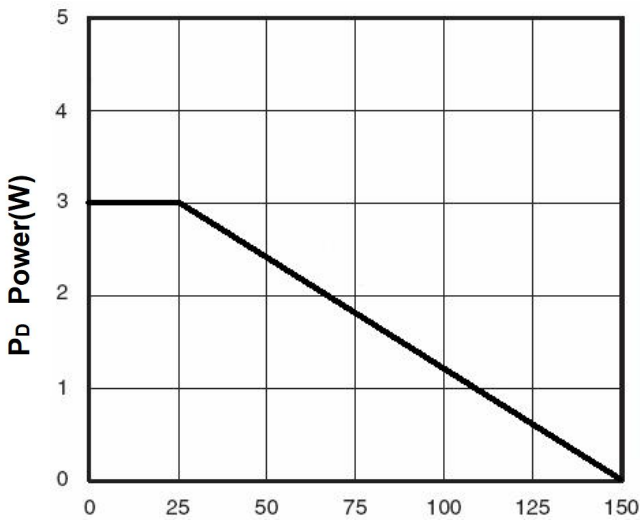


Figure 3 Power Dissipation

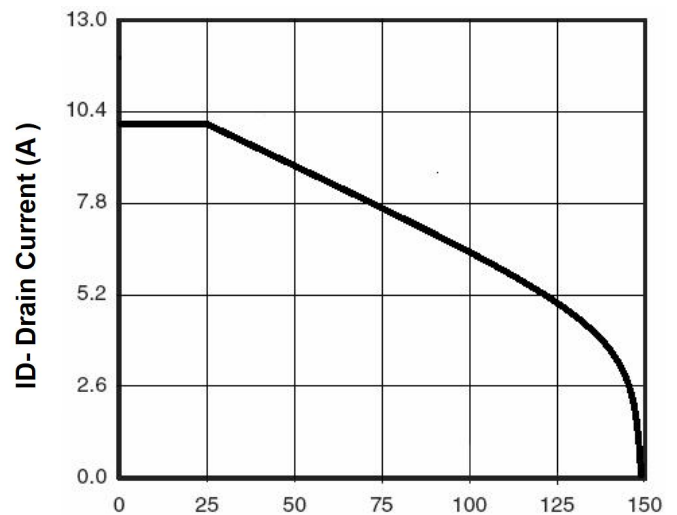


Figure 4 Drain Current

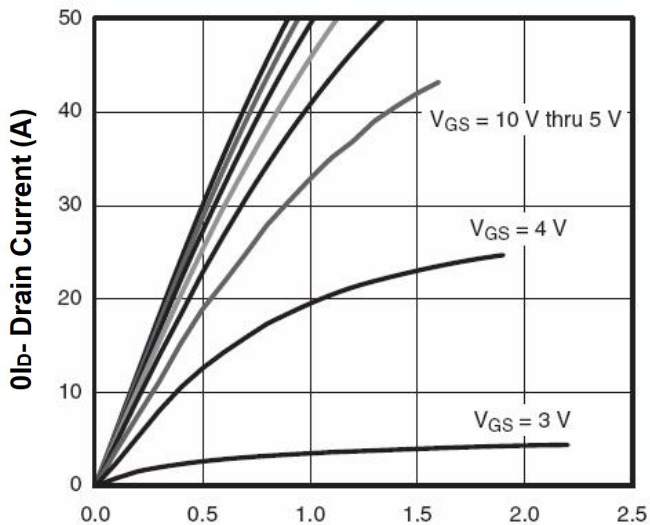


Figure 5 Output Characteristics

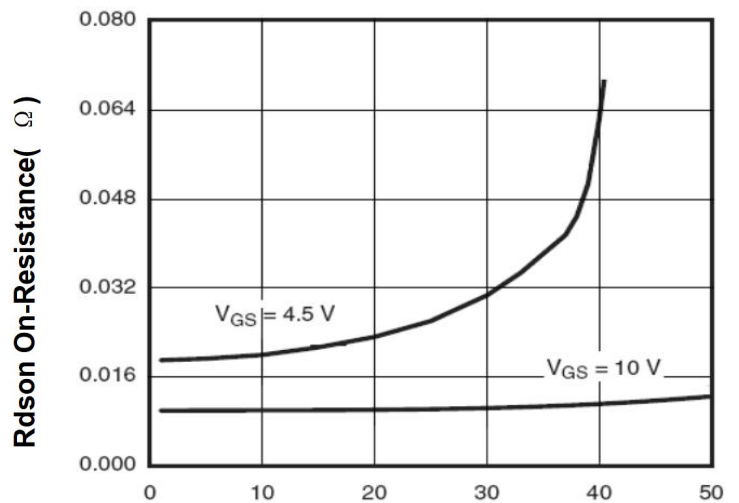


Figure 6 Drain-Source On-Resistance

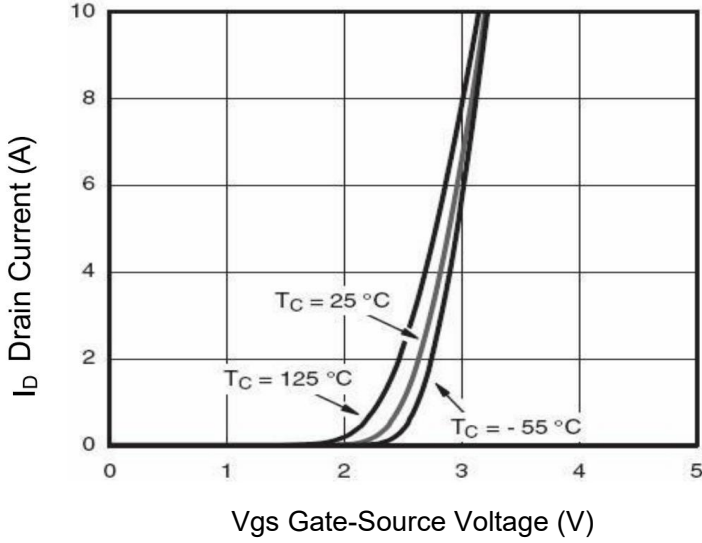


Figure 7 Transfer Characteristics

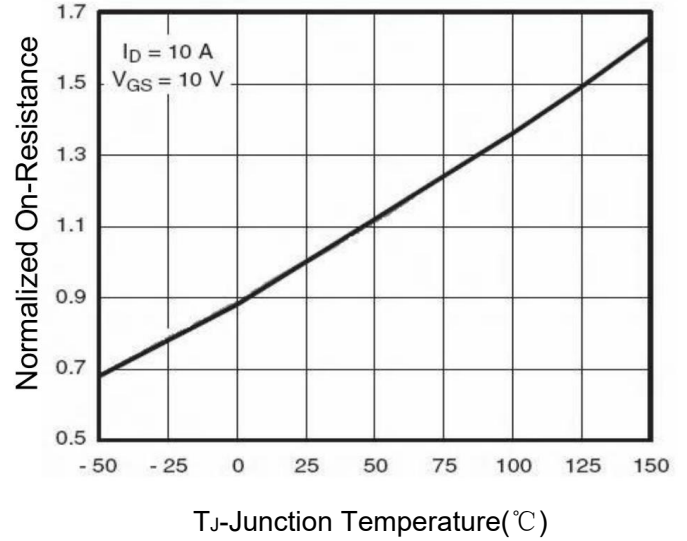


Figure 8 Drain-Source On-Resistance

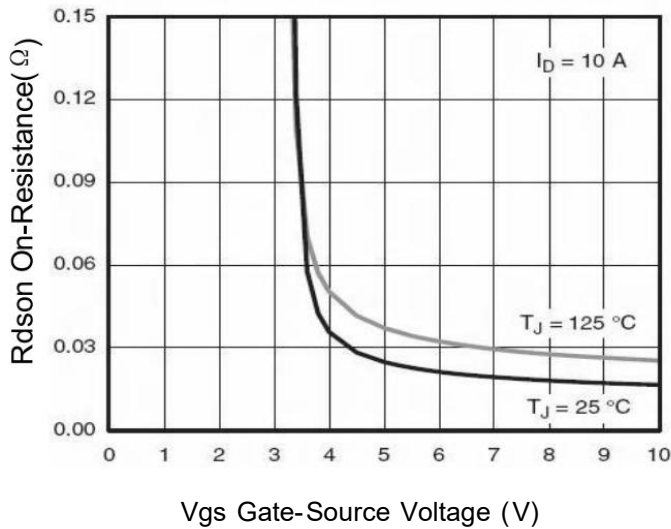


Figure 9 $R_{DS(on)}$ vs V_{GS}

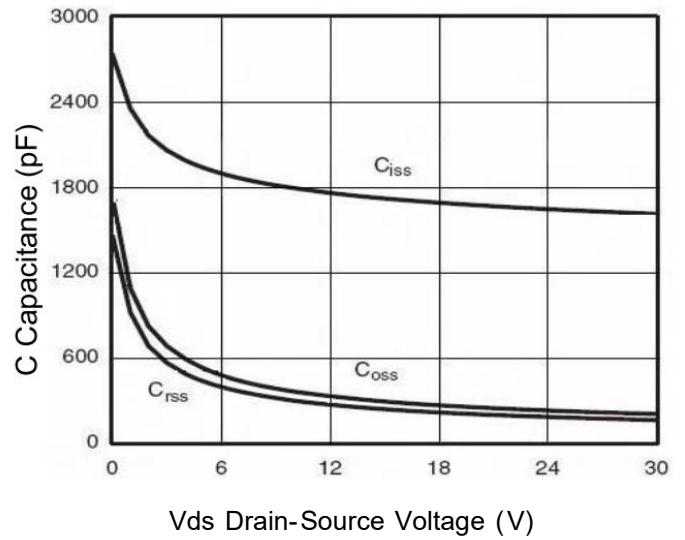


Figure 10 Capacitance vs V_{DS}

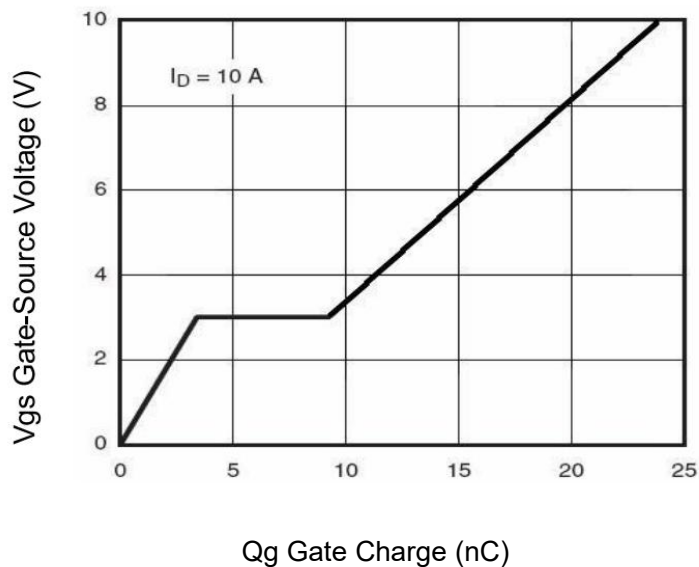


Figure 11 Gate Charge

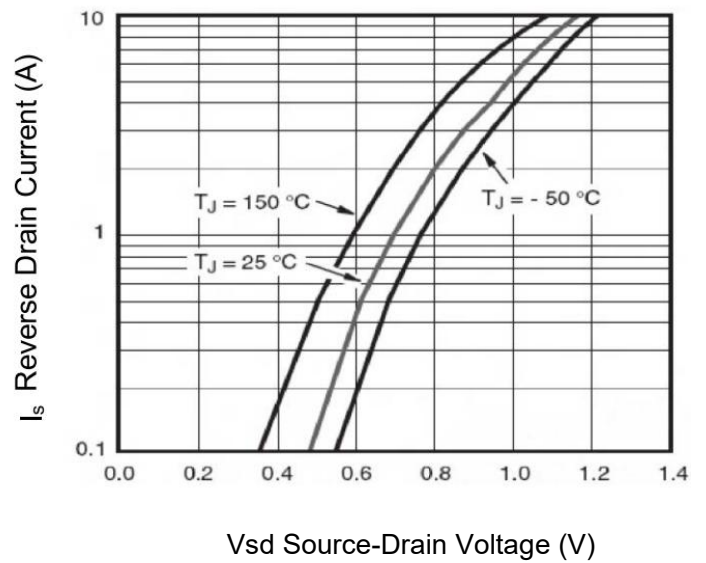


Figure 12 Source-Drain Diode Forward

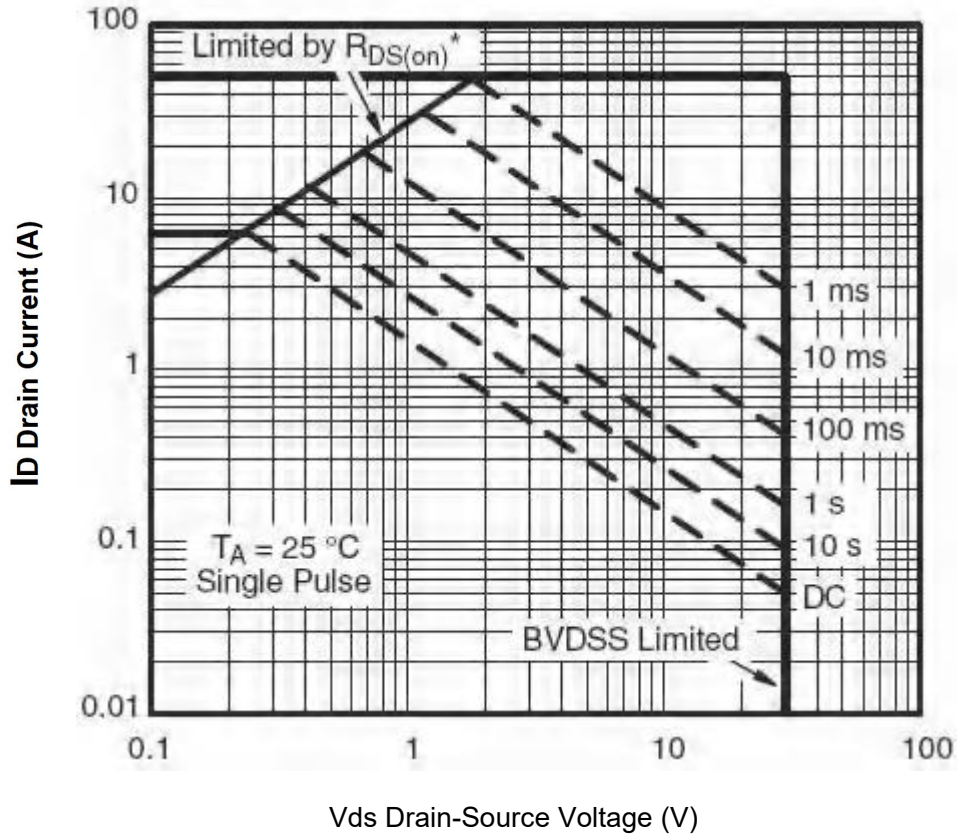


Figure 13 Safe Operation Area

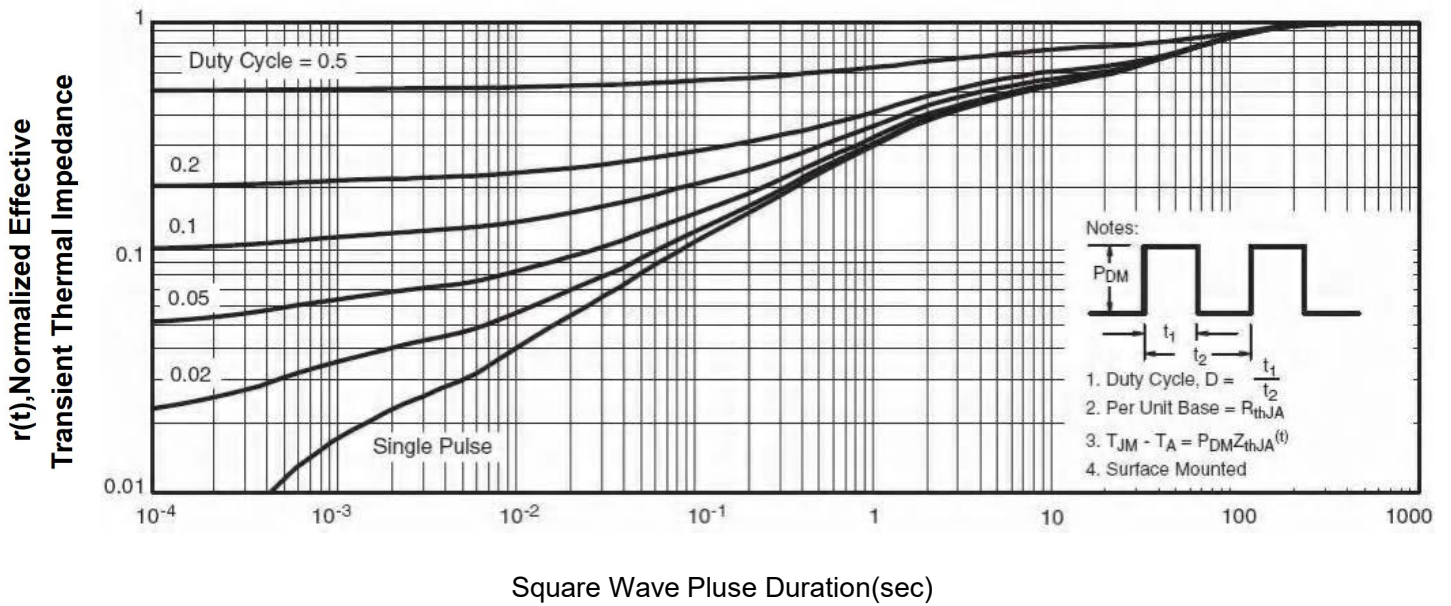
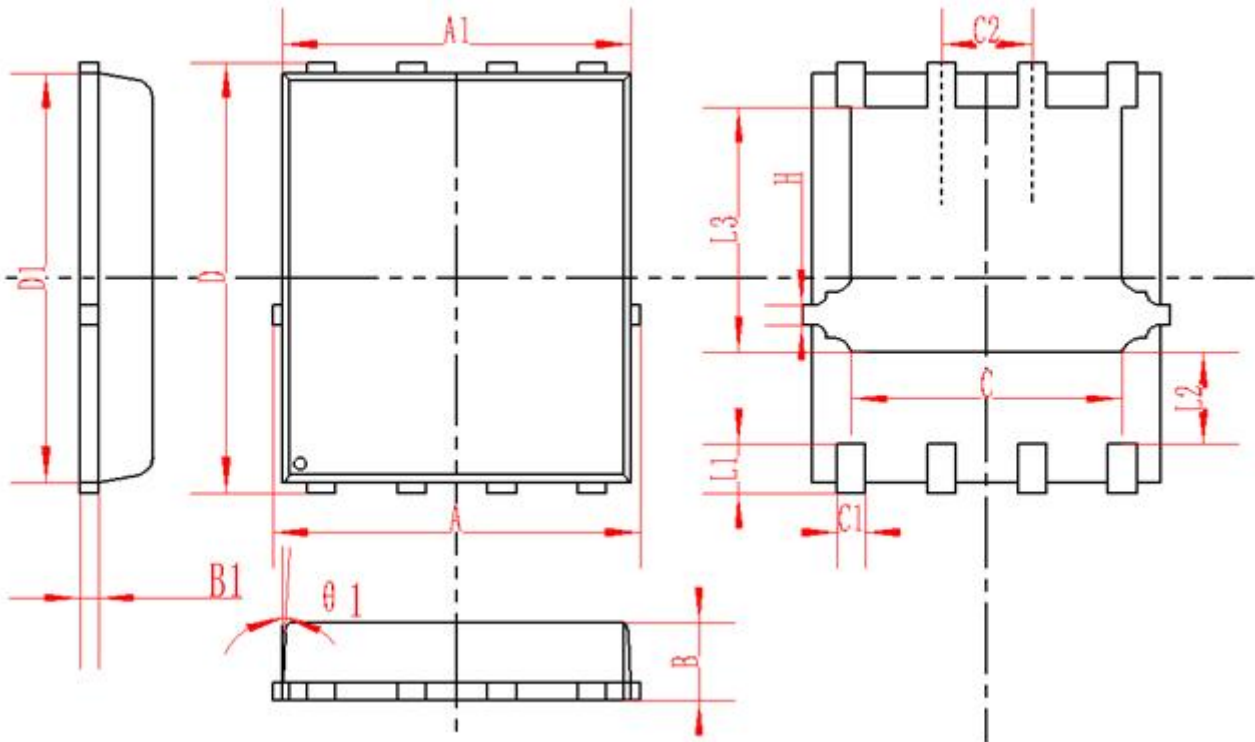


Figure 14 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
B	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF			0.010REF		
C	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2	1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
H	0.24	0.25	0.26	0.009	0.010	0.010

REEL SPECIFICATION

P/N	PKG	QTY
FDMC4435BZ-MS	DFN5X6-8L	5000

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